

Quick Start Guide GreenPAK In-System Programming Board

Quick Start Guide



GreenPAK In-System Programming Board

Contents

Contents			
Figures			
Tables	2		
1 Terms and Definitions	3		
2 Description	4		
Appendix A Board Schematic Diagram			
Appendix B BOM			
Revision History	8		
Figures			
Figure 1: PCBFigure 2: PCB Top View			
Tables			
Table 1: ISP States Board			
Table 2: Board Protections	5		



1 Terms and Definitions

FET Field-Effect Transistor

GND Ground

ISP In-System Programming

LDO Low Dropout Voltage Regulator

LED Light Emitting Diode
OCP Over Current Protection
OTP Over Temperature Protection
OVP Over Voltage Protection
PCB Printed Circuit Board

SCL I²C Clock Input

SCP Short Circuit Protection
SDA I²C Data Input/Output
USB Universal Serial Bus

V_{DD} Power Supply



2 Description

The In-System Programming (ISP) Board is a small PCB that allows to emulate and program the SLG46826/4 chip without using the Universal Development Board. The chip is programmed/emulated through the I^2C protocol via four SLG46826/4 pins: V_{DD} , SCL, SDA, and GND.

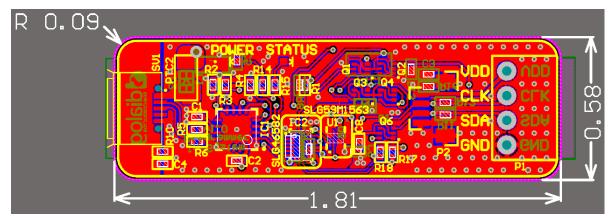


Figure 1: PCB

Note 1 All sizes in inches.

The ISP board can be used with GreenPAK Designer version 6.xx and above. Select "ISP" in the "Development Platform Selector" window and click on the "Program" or "Emulate" button.

When the ISP board is connected to USB port, "Power" LED turns on. The ISP Programmer connector (P1 or P2) pins should be connected to the external board in order to the SLG46826/4 (programmed) chip could be powered from the ISP or from external power supply. The ISP board detects external power and switches off its V_{DD} line (in this case, I^2C pull-up resistors are connected to the external power).

There are two options for the user to make a connection between the ISP board and their target board:

- 1) The P1 connector has four signals for SDA, SCL, power, and ground. This connector can be used to make physical and electrical connection to the target board. To enable this, the User should place a duplicate of this connector on the target board. The part number of this connector is Molex Connector Corporation 0022152046. This connector was chosen for its small physical size.
- 2) The P2 connector also has the same four signals for SDA, SCL, power, and ground. This connector has 0.1" spacing, which will support a variety of industry standard cabling options. Additionally Target Board Cable is included with the ISP Board. If the User prefers to use this option, the cabling mating connector on the target board must be chosen. The part number for this connector is BM04B-SRSS-TB(LF)(SN).

Table 1: ISP States Board

ISP State	Power LED	Status LED
Standby mode	On	Off
Emulation mode	On	Blink
Program mode	On	Blink
Over voltage protection at V _{DD} line	Blink	Off
Over temperature protection	Off	Off



Table 2: Board Protections

Protection	Description
Over current protection (OCP)	PTC limits maximum V _{DD} current equals 100 mA
Short circuit protection (SCP)	PTC limits maximum V _{DD} current equals 100 mA
Over voltage protection (OVP)	When the external power supply voltage exceeded 5.6 V, FET U1 and power supply LDO IC2 are turned off and Power LED starts to blink.
Over temperature protection (OTP)	When the IC2 temperature exceeds 75 °C, FET U1 and power supply LDO IC2 are turned off and Power and Status LEDs are also turned off.

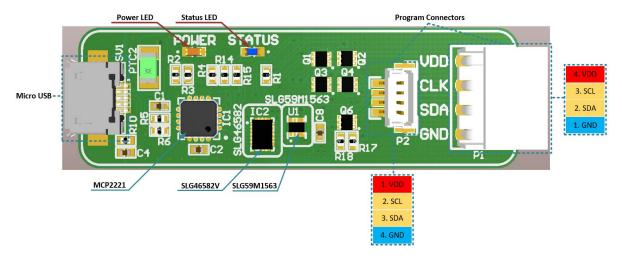
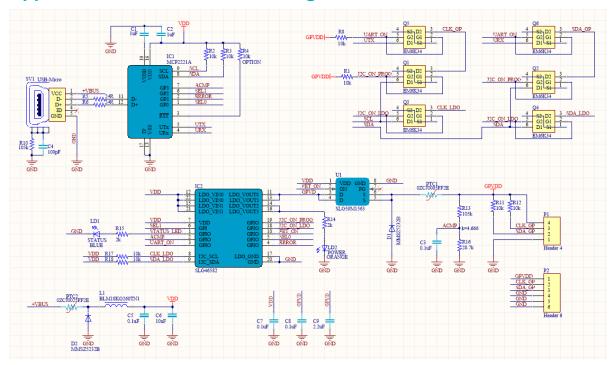


Figure 2: PCB Top View



Appendix A Board Schematic Diagram





Appendix B BOM

#	Designator	Description	Footprint	Quantity
1	C1, C2	CAP CER 1 μF 10V Y5V 0402	C0402	2
2	C3, C4	CAP CER 100 pF 10V X7R 0402	C0402	2
3	C5, C7, C8	CAP CER 0.1 μF 10V X5R 0402	C0402	3
4	C6	CAP CER 10 μF 10V X5R 0805	C0805	1
5	C9	CAP CER 2.2 μF 10V X5R 0402	C0402	1
6	D1, D2	TVS DIODE 5VWM 9.2VC SOD123W	SOD123	2
7	IC1	IC USB TO I2C BRIDGE DEVICE 16QF	QFN16-4.0x4.0	1
8	IC2		STQFN-20L-2.0x3.0	1
9	L1	FERRITE BEAD 26 Ω 0603 1LN	F0603	1
10	LD1	LED BLUE CLEAR 0603 SMD	LED0603_BLUE	1
11	LD2	Orange 605nm LED Indication - Discrete 2.2V 0603 (1608 Metric)	LED0603_ORANGE	1
12	P1	Molex Connector Corporation 0022152046	MOLEX_4pin	1
13	PTC1	PTC RESET FUSE 60V 50MA 1206	R_1206	1
14	PTC2	PTC RESET FUSE 16V 250MA 1206	R_1206	1
15	Q1, Q2, Q3, Q4, Q5, Q6	MOSFET 2N-CH 50V 0.2A EMT6	SOT-563	6
16	R1, R2, R3, R8, R11, R12, R17, R18	RES SMD 24 Ω 5% 1/16W 0402	RES 0402L (1005)	8
17	R5, R6	RES SMD 100 kΩ 1% 1/16W 040	RES 0402L (1005)	2
18	R10, R13	RES SMD 100 kΩ1% 1/16W 0402	RES 0402L (1005)	2
19	R14, R15	RES SMD 2 kΩ 1% 1/16W 0402	RES 0402L (1005)	2
20	R16	RES SMD 21.5 Ω 1% 1/16W 0402	RES 0402L (1005)	1
21	SV1	CONN USB MICRO B RECPT SMT R/A	Micro USB	1
22	U1		WLCSP_0.8X0.8_4L	1
23	P2	BM04B-SRSS-TB(LF)(SN)	BM04B_WHITE	1



Revision History

Revision	Date	Description
1.1	14-Sep-2020	Updated according to Dialog's Writing Guideline



Status Definitions

Status	Definition
DRAFT	The content of this document is under review and subject to formal approval, which may result in modifications or additions.
APPROVED or unmarked	The content of this document has been approved for publication.

Disclaimer

Unless otherwise agreed in writing, the Dialog Semiconductor products (and any associated software) referred to in this document are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of a Dialog Semiconductor product (or associated software) can reasonably be expected to result in personal injury, death or severe property or environmental damage. Dialog Semiconductor and its suppliers accept no liability for inclusion and/or use of Dialog Semiconductor products (and any associated software) in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Information in this document is believed to be accurate and reliable. However, Dialog Semiconductor does not give any representations or warranties, express or implied, as to the accuracy or completeness of such information. Dialog Semiconductor furthermore takes no responsibility whatsoever for the content in this document if provided by any information source outside of Dialog Semiconductor.

Dialog Semiconductor reserves the right to change without notice the information published in this document, including, without limitation, the specification and the design of the related semiconductor products, software and applications. Notwithstanding the foregoing, for any automotive grade version of the device, Dialog Semiconductor reserves the right to change the information published in this document, including, without limitation, the specification and the design of the related semiconductor products, software and applications, in accordance with its standard automotive change notification process.

Applications, software, and semiconductor products described in this document are for illustrative purposes only. Dialog Semiconductor makes no representation or warranty that such applications, software and semiconductor products will be suitable for the specified use without further testing or modification. Unless otherwise agreed in writing, such testing or modification is the sole responsibility of the customer and Dialog Semiconductor excludes all liability in this respect.

Nothing in this document may be construed as a license for customer to use the Dialog Semiconductor products, software and applications referred to in this document. Such license must be separately sought by customer with Dialog Semiconductor.

All use of Dialog Semiconductor products, software and applications referred to in this document is subject to Dialog Semiconductor's Standard Terms and Conditions of Sale, available on the company website (www.dialog-semiconductor.com) unless otherwise stated.

Dialog, Dialog Semiconductor and the Dialog logo are trademarks of Dialog Semiconductor Plc or its subsidiaries. All other product or service names and marks are the property of their respective owners.

© 2020 Dialog Semiconductor. All rights reserved.

RoHS Compliance

Dialog Semiconductor's suppliers certify that its products are in compliance with the requirements of Directive 2011/65/EU of the European Parliament on the restriction of the use of certain hazardous substances in electrical and electronic equipment. RoHS certificates from our suppliers are available on request.

Contacting Dialog Semiconductor

United Kingdom (Headquarters)

Dialog Semiconductor (UK) LTD Phone: +44 1793 757700

Germany

Dialog Semiconductor GmbH Phone: +49 7021 805-0

The Netherlands

Dialog Semiconductor B.V. Phone: +31 73 640 8822

Email

enquiry@diasemi.com

North America

Dialog Semiconductor Inc. Phone: +1 408 845 8500

Japan

Dialog Semiconductor K. K. Phone: +81 3 5769 5100

Taiwan

Dialog Semiconductor Taiwan Phone: +886 281 786 222

Web site:

www.dialog-semiconductor.com

Hong Kong

Dialog Semiconductor Hong Kong Phone: +852 2607 4271

Korea

Dialog Semiconductor Korea Phone: +82 2 3469 8200 China (Shenzhen)

Dialog Semiconductor China Phone: +86 755 2981 3669

China (Shanghai)

Dialog Semiconductor China Phone: +86 21 5424 9058

Revision 1.1

14-Sep-2020